

FEATURES

- Small package.
- High speed switching.

**APPLICATIONS**

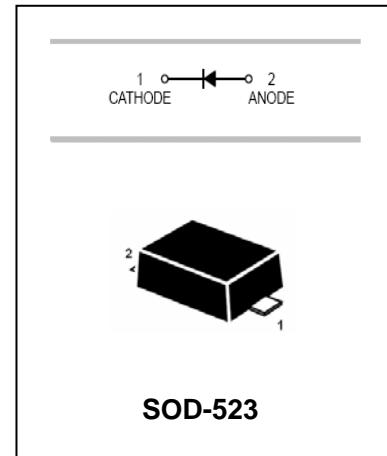
- High speed switching application.

ORDERING INFORMATION

Type No.	Marking	Package Code
BAS16X	A6	SOD-523

MAXIMUM RATING @ Ta=25°C unless otherwise specified

Parameter	Symbol	Limits	Unit
Peak repetitive reverse voltage	V _{RRM}		
Working peak reverse voltage	V _{RWM}	85	V
DC Reverse voltage	V _R		
RMS Reverse voltage	V _{R(RMS)}	60	V
Continuous forward current	I _F	155	mA
Repetitive peak forward current	I _{FRM}	500	mA
Non-Repetitive peak forward surge current @t=1.0μs @t=1.0ms @t=1.0s	I _{FSM}	4.0 1.0 0.5	A
Total power dissipation	P _{tot}	150	mW
Total resistance junction to ambient	R _{θJA}	833	°C/W
Junction temperature	T _j	150	°C
Storage temperature	T _{stg}	-65 to +150	°C



ELECTRICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Reverse breakdown voltage	$V_{(BR)R}$	85			V	$I_R=100\mu\text{A}$
Forward voltage	V_F			0.715 0.815 1 1.25	V	$I_F=1\text{mA}$ $I_F=10\text{mA}$ $I_F=50\text{mA}$ $I_F=150\text{mA}$
Reverse current	I_R			2.0 30	μA nA	$V_R=75\text{V}$ $V_R=25\text{V}$
Diode capacitance	C_d			1.5	pF	$V_R=0\text{V}, f=1\text{MHz}$
Reverse recovery time	t_{rr}			4	ns	$I_F=I_R=10\text{mA}, R_L=100\Omega$

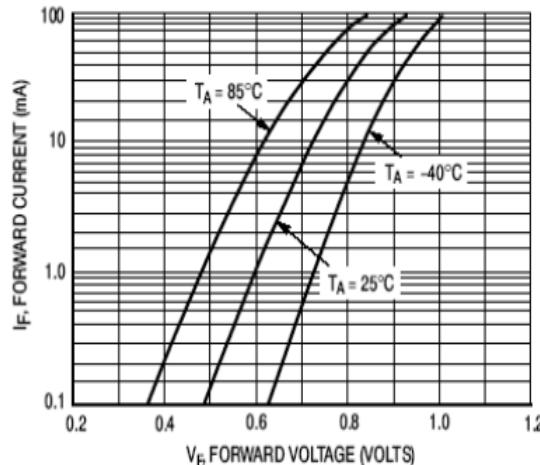
TYPICAL CHARACTERISTICS @ $T_a=25^\circ\text{C}$ unless otherwise specified

Figure 2. Forward Voltage

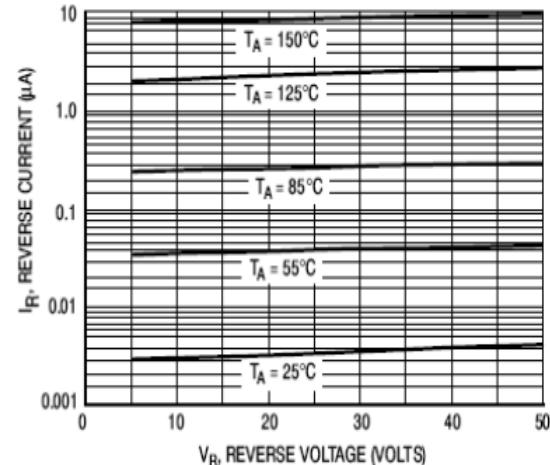


Figure 3. Leakage Current

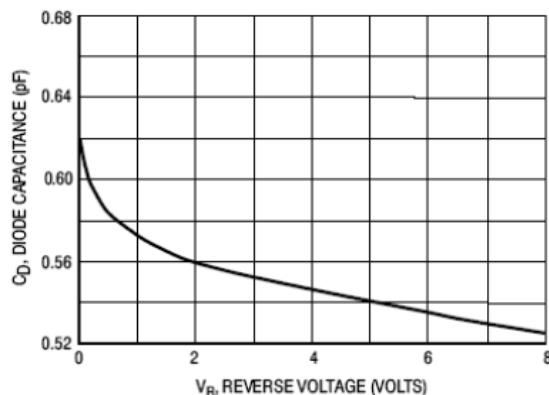
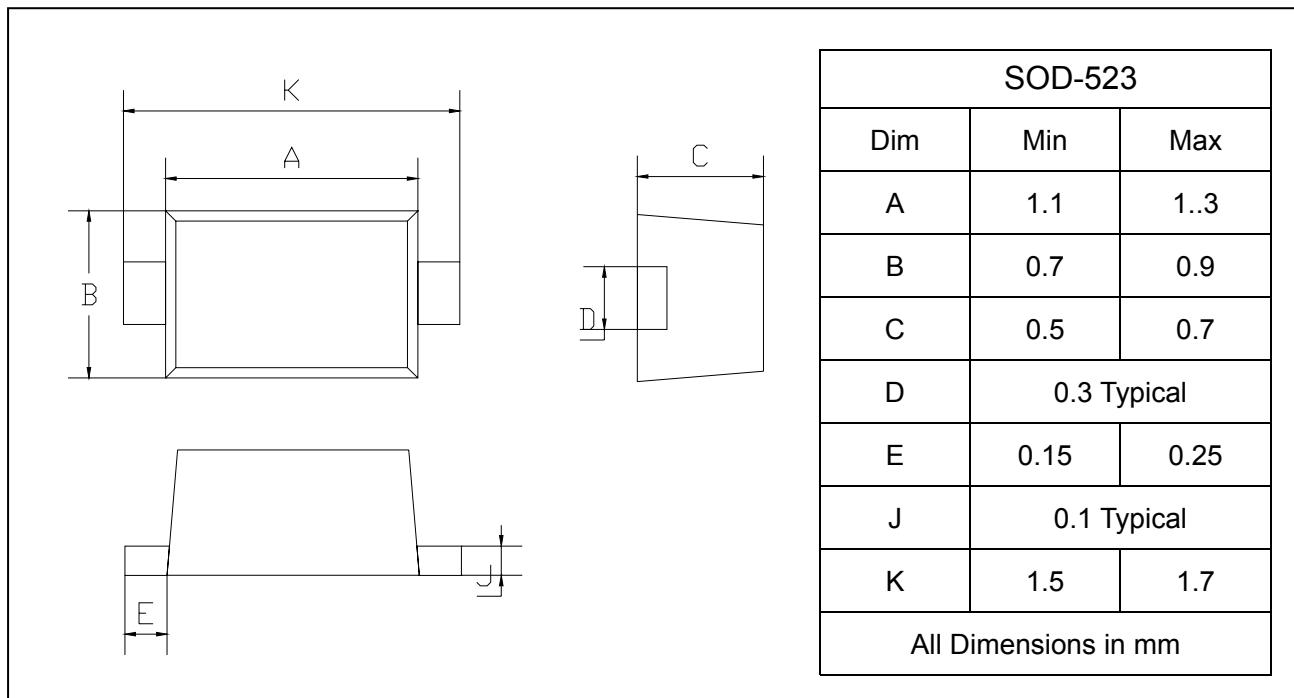


Figure 4. Capacitance

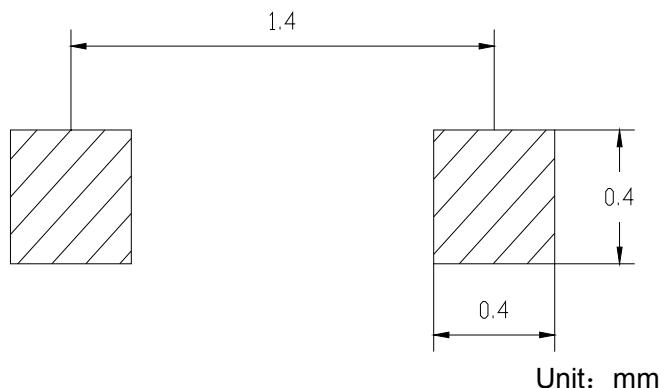
PACKAGE OUTLINE

Plastic surface mounted package

SOD-523



SOLDERING FOOTPRINT



PACKAGE INFORMATION

Device	Package	Shipping
BAS16X	SOD-523	3000/Tape&Reel